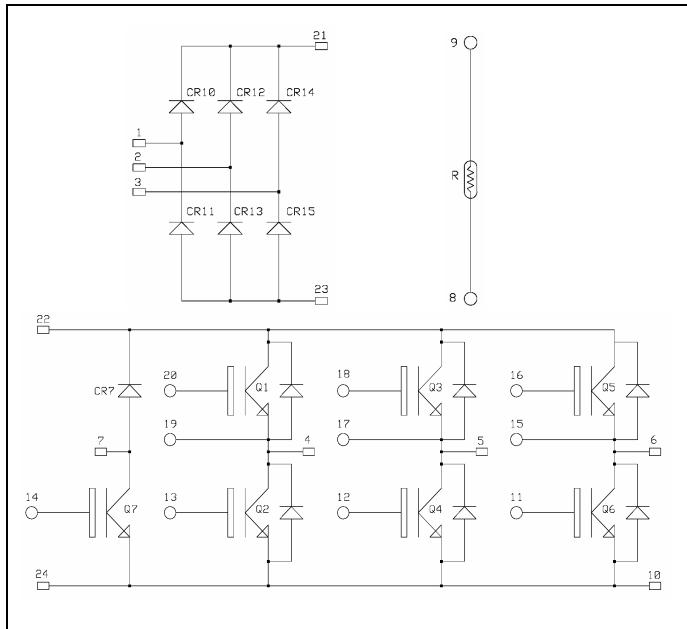
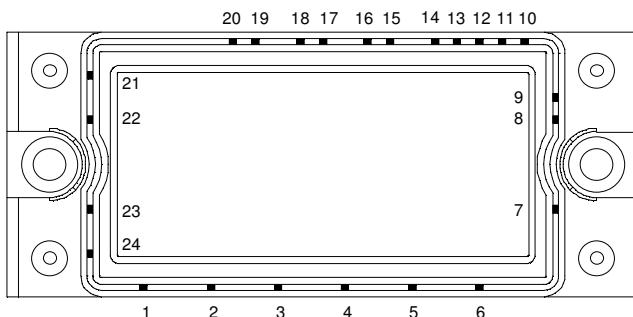


*Input rectifier bridge +
Brake + 3 Phase Bridge
NPT IGBT Power Module*

**V_{CES} = 600V
I_C = 30A @ T_c = 80°C**



APTGF30X60RTP2: Without Brake (Pin 7 & 14 not connected)



All ratings @ T_j = 25°C unless otherwise specified

1. Absolute maximum ratings

Diode rectifier Absolute maximum ratings

Symbol	Parameter	Max ratings	Unit
V _{RRM}	Repetitive Peak Reverse Voltage	1600	V
I _D	DC Forward Current	T _c = 80°C 30	A
I _{FSM}	Surge Forward Current	T _j = 25°C 300	
	t _p = 10ms	T _j = 150°C 230	

 CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

IGBT & Diode Brake (only for APTGF30X60BTP2) Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		600	V
I_C	Continuous Collector Current	$T_C = 25^\circ C$	25	A
		$T_C = 80^\circ C$	15	
I_{CM}	Pulsed Collector Current	$T_C = 25^\circ C$	37	
V_{GE}	Gate – Emitter Voltage		± 20	V
P_D	Maximum Power Dissipation	$T_C = 25^\circ C$	100	W
I_F	DC Forward Current	$T_C = 80^\circ C$	10	A

IGBT & Diode Inverter Absolute maximum ratings

Symbol	Parameter		Max ratings	Unit
V_{CES}	Collector - Emitter Breakdown Voltage		600	V
I_C	Continuous Collector Current	$T_C = 25^\circ C$	50	A
		$T_C = 80^\circ C$	30	
I_{CM}	Pulsed Collector Current	$T_C = 25^\circ C$	75	
V_{GE}	Gate – Emitter Voltage		± 20	V
P_D	Maximum Power Dissipation	$T_C = 25^\circ C$	180	W
SCSOA	Short circuit Safe Operating Area	$T_j = 125^\circ C$	120A @ 360V	
I_F	DC Forward Current	$T_C = 80^\circ C$	30	A
I_{FSM}	Surge Forward Current	$t_p = 1ms$	$T_C = 80^\circ C$	
			60	

2. Electrical Characteristics

Diodes Rectifier Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_R	Reverse Current	$V_R = 1600V$	$T_j = 150^\circ C$		2		mA
V_F	Forward Voltage	$I_F = 30A$	$T_j = 25^\circ C$		1.3	1.5	V
		$I_F = 30A$	$T_j = 150^\circ C$		1.1	1.15	
R_{thJC}	Junction to Case					1	°C/W

IGBT Brake & Diode (only for APTGF30X60BTP2) Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
I_{CES}	Zero Gate Voltage Collector Current	$V_{GE} = 0V$	$T_j = 25^\circ C$		0.5	500	μA
		$V_{CE} = 600V$	$T_j = 125^\circ C$		0.8		mA
$V_{CE(on)}$	Collector Emitter on Voltage	$V_{GE} = 15V$	$T_j = 25^\circ C$		1.95	2.45	V
		$I_C = 15A$	$T_j = 125^\circ C$		2.2		
$V_{GE(th)}$	Gate Threshold Voltage	$V_{GE} = V_{CE}$, $I_C = 0.4mA$		4.5	5.5	6.5	V
I_{GES}	Gate – Emitter Leakage Current	$V_{GE} = 20V$, $V_{CE} = 0V$			300		nA
C_{ies}	Input Capacitance	$V_{GE} = 0V$, $V_{CE} = 25V$ $f = 1MHz$			800		pF
V_F	Forward Voltage	$V_{GE} = 0V$	$T_j = 25^\circ C$		1.25	1.7	V
		$I_F = 30A$	$T_j = 125^\circ C$		1.2		
R_{thJC}	Junction to Case			IGBT		1.3	°C/W
				Diode		1.2	

IGBT & Diode Inverter Electrical Characteristics

Symbol	Characteristic	Test Conditions		Min	Typ	Max	Unit
BV _{CES}	Collector - Emitter Breakdown Voltage	V _{GE} = 0V, I _C = 500µA		600			V
I _{CES}	Zero Gate Voltage Collector Current	V _{GE} = 0V	T _j = 25°C		1.0	500	µA
		V _{CE} = 600V	T _j = 125°C		1.2		mA
V _{CE(on)}	Collector Emitter on Voltage	V _{GE} = 15V	T _j = 25°C		1.95	2.45	V
		I _C = 30A	T _j = 125°C		2.2		
V _{GE(th)}	Gate Threshold Voltage	V _{GE} = V _{CE} , I _C = 0.7 mA		4.5	5.5	6.5	V
I _{GES}	Gate – Emitter Leakage Current	V _{GE} = 20V, V _{CE} = 0V			300		nA
C _{ies}	Input Capacitance	V _{GE} = 0V, V _{CE} = 25V f = 1MHz			1600		pF
T _{d(on)}	Turn-on Delay Time	Inductive Switching (25°C) V _{GE} = ±15V V _{Bus} = 300V I _C = 30A R _G = 33Ω			50		ns
T _r	Rise Time				50		
T _{d(off)}	Turn-off Delay Time				250		
T _f	Fall Time				30		
T _{d(on)}	Turn-on Delay Time				50		ns
T _r	Rise Time	Inductive Switching (125°C) V _{GE} = ±15V V _{Bus} = 300V I _C = 30A R _G = 33Ω			50		
T _{d(off)}	Turn-off Delay Time				270		
T _f	Fall Time				40		
E _{off}	Turn off Energy				1		mJ
V _F	Forward Voltage	V _{GE} = 0V I _F = 30A	T _j = 25°C T _j = 125°C		1.25	1.7	V
Q _{rr}	Reverse Recovery Charge	I _F = 30A V _R = 300V di/dt=900A/µs	T _j = 25°C		2.5		µC
			T _j = 125°C		4		
R _{thJC}	Junction to Case		IGBT			0.7	°C/W
			Diode			1.2	

Temperature sensor NTC

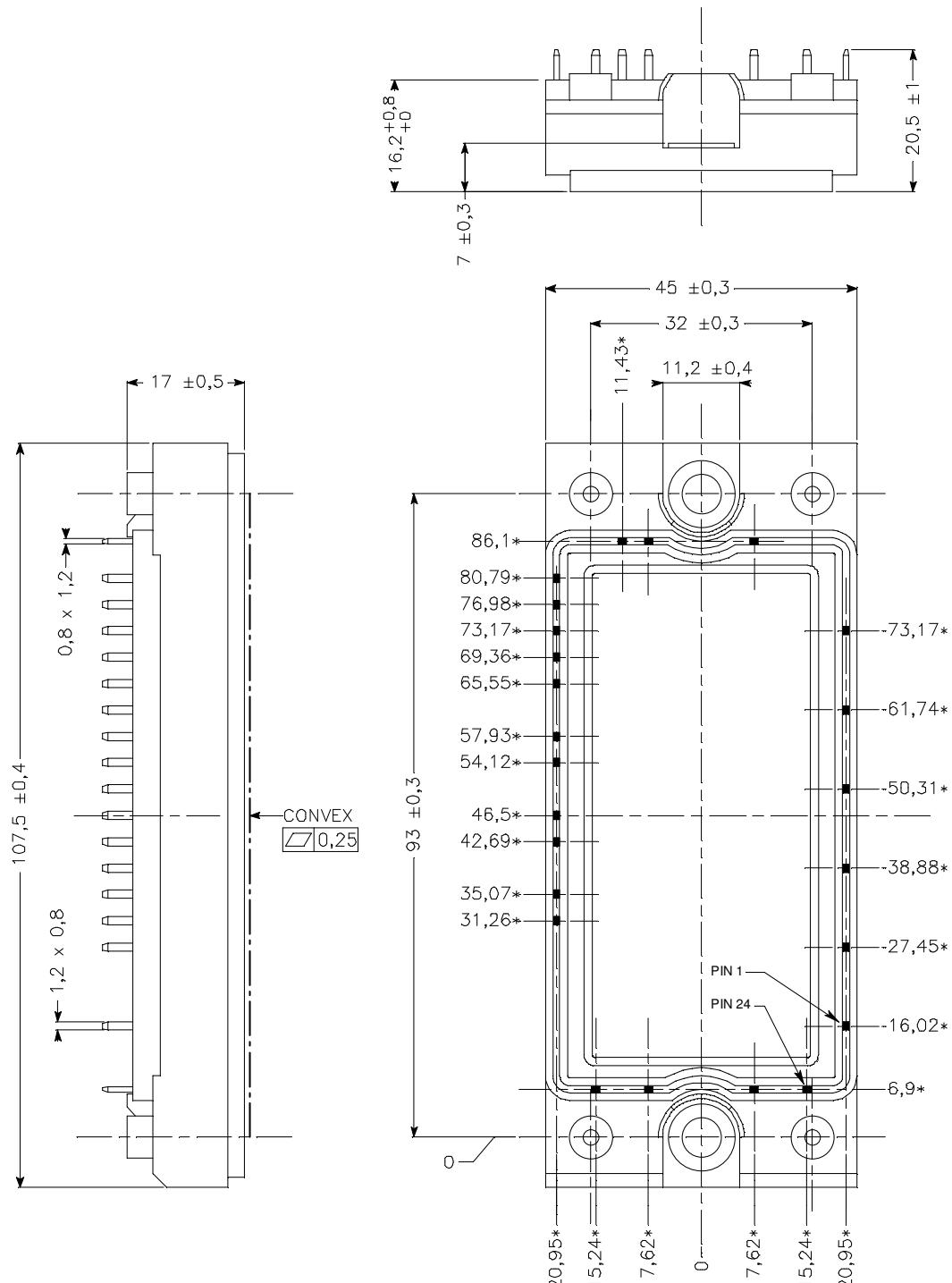
Symbol	Characteristic	Min	Typ	Max	Unit
R ₂₅	Resistance @ 25°C		5		kΩ
B _{25/50}	T ₂₅ = 298.16 K		3375		K

$$R_T = \frac{R_{25}}{\exp\left[B_{25/50}\left(\frac{1}{T_{25}} - \frac{1}{T}\right)\right]}$$

T: Thermistor temperature
R_T: Thermistor value at T

3. Thermal and package characteristics

Symbol	Characteristic	Min	Typ	Max	Unit
V _{ISOL}	RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz	2500			V
T _J	Operating junction temperature range	-40		150	°C
T _{STG}	Storage Temperature Range	-40		125	
T _C	Operating Case Temperature	-40		125	
Torque	Mounting torque	To Heatsink	M5		N.m
Wt	Package Weight			185	g

4. Package outline

 ALL DIMENSIONS MARKED " * " ARE TOLERENCED AS : 
APT reserves the right to change, without notice, the specifications and information contained herein

APT's products are covered by one or more of U.S patents 4,895,810 5,045,903 5,089,434 5,182,234 5,019,522 5,262,336 6,503,786 5,256,583 4,748,103 5,283,202 5,231,474 5,434,095 5,528,058 and foreign patents. U.S and Foreign patents pending. All Rights Reserved.